



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 0805 |
| L | 2mm +/-0.2mm |
| W | 1.25mm +/-0.2mm |
| T | 0.85mm +/-0.2mm |
| B | 0.5mm +/-0.3mm |

Packaging Specifications

| | |
|--------------------|------|
| Packaging | T&R |
| Packaging Quantity | 4000 |

General Information

| | |
|-------------|--|
| Series | Z-PWS |
| Style | SMD Chip |
| Description | Chip Bead, Power Line |
| Features | Broadband |
| RoHS | Yes |
| Notes | Last Order Date June 30, 2023. Suggested Replacement - https://productfinder.pulseelectronics.com/part/BBUP00201209300Y00 . |

Specifications

| | |
|---------------------|-------------------|
| Impedance | 25 Ohms (100 MHz) |
| Impedance Tolerance | 30% |
| Ripple Current | 6000 mA (MAX) |
| Temperature Range | -40/+125°C |
| DC Resistance | 0.004 Ohms |